

54AC16240, 74AC16240 16-BIT BUS DRIVERS WITH 3-STATE OUTPUTS

SCAS234B – JULY 1990 – REVISED OCTOBER 1996

- Members of the Texas Instruments *Widebus*™ Family
- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- Flow-Through Architecture Optimizes PCB Layout
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- *EPIC*™ (Enhanced-Performance Implanted CMOS) 1- μ m Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) Package Using 25-mil Center-to-Center Pin Spacings and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Pin Spacings

description

The 'AC16240 are 16-bit buffers and line drivers designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

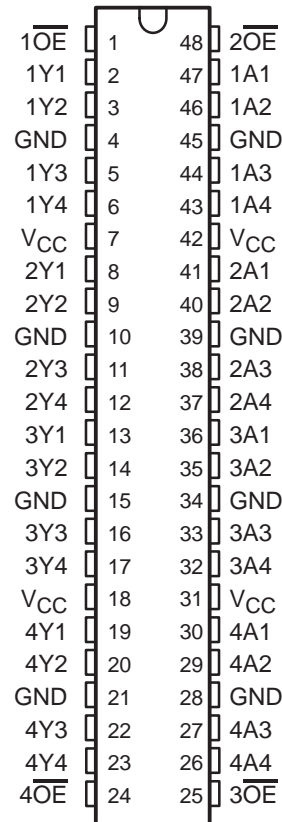
They can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. These devices provide inverting outputs and symmetrical active-low output-enable (\overline{OE}) inputs.

The 74AC16240 is packaged in TI's shrink small-outline package, which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed circuit board area.

The 54AC16240 is characterized for operation over the full military temperature range of –55°C to 125°C.

The 74AC16240 is characterized for operation from –40°C to 85°C.

54AC16240 . . . WD PACKAGE
74AC16240 . . . DL PACKAGE
(TOP VIEW)



FUNCTION TABLE
(each 4-bit buffer)

INPUTS		OUTPUT
\overline{OE}	A	Y
L	H	L
L	L	H
H	X	Z



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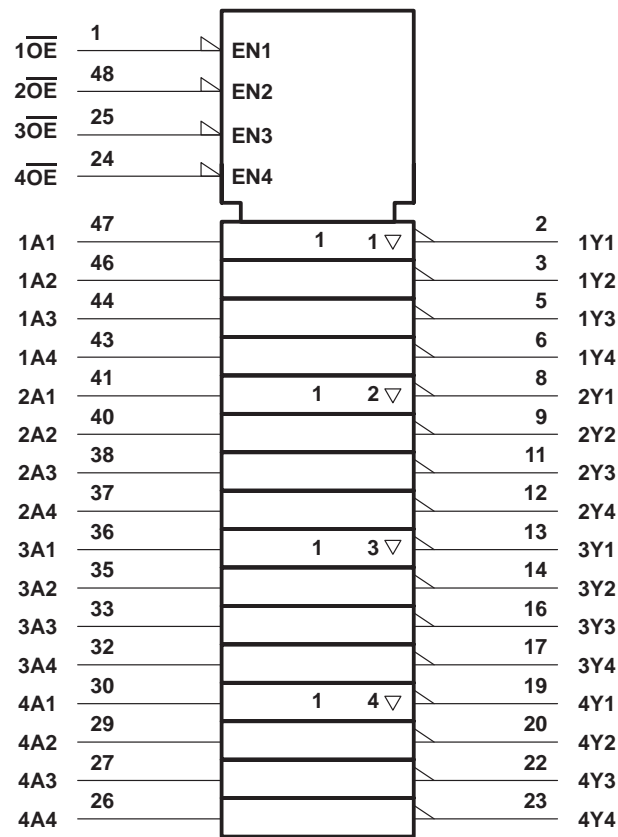
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**TEXAS
INSTRUMENTS**

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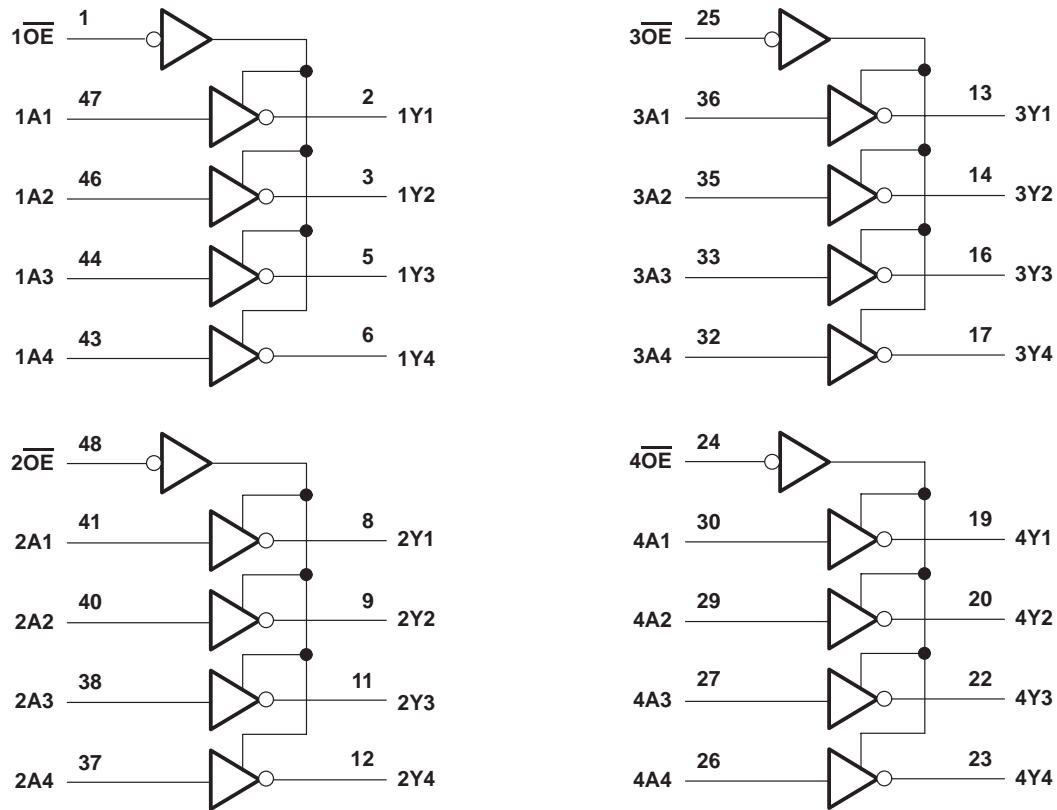
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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input voltage range, V_I (see Note 1)	–0.5 V to $V_{CC} + 0.5$ V
Output voltage range, V_O (see Note 1)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	± 20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	± 50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	± 50 mA
Continuous current through V_{CC} or GND	± 400 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air)(see Note 2): DL package	1.2 W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

recommended operating conditions (see Note 3)

			54AC16240			74AC16240			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage		3	5	5.5	3	5	5.5	V
V _{IH}	High-level input voltage	V _{CC} = 3 V	2.1			2.1			V
		V _{CC} = 4.5 V	3.15			3.15			
		V _{CC} = 5.5 V	3.85			3.85			
V _{IL}	Low-level input voltage	V _{CC} = 3 V	0.9			0.9			V
		V _{CC} = 4.5 V	1.35			1.35			
		V _{CC} = 5.5 V	1.65			1.65			
V _I	Input voltage		0	V _{CC}		0	V _{CC}		V
V _O	Output voltage		0	V _{CC}		0	V _{CC}		V
I _{OH}	High-level output current	V _{CC} = 3 V	−4			−4			mA
		V _{CC} = 4.5 V	−24			−24			
		V _{CC} = 5.5 V	−24			−24			
I _{OL}	Low-level output current	V _{CC} = 3 V	12			12			mA
		V _{CC} = 4.5 V	24			24			
		V _{CC} = 5.5 V	24			24			
Δt/Δv	Input transition rise or fall rate		0	10		0	10		ns/V
T _A	Operating free-air temperature		−55	125		−40	85		°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V_{CC}	$T_A = 25^\circ\text{C}$			54AC16240		74AC16240		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V_{OH}	$I_{OH} = -50\text{ }\mu\text{A}$	3 V	2.9			2.9		2.9		V
		4.5 V	4.4			4.4		4.4		
		5.5 V	5.4			5.4		5.4		
	$I_{OH} = -4\text{ mA}$	3 V	2.58			2.48		2.48		
		4.5 V	3.94			3.8		3.8		
	$I_{OH} = -24\text{ mA}$	4.5 V	4.94			4.8		4.8		
		5.5 V				3.85		3.85		
V_{OL}	$I_{OL} = 50\text{ }\mu\text{A}$	3 V			0.1		0.1		0.1	V
		4.5 V			0.1		0.1		0.1	
		5.5 V			0.1		0.1		0.1	
	$I_{OL} = 12\text{ mA}$	3 V			0.36		0.44		0.44	
		4.5 V			0.36		0.44		0.44	
	$I_{OL} = 24\text{ mA}$	4.5 V			0.36		0.44		0.44	
		5.5 V			0.36		0.44		0.44	
I_I	$V_I = V_{CC}$ or GND	5.5 V			± 0.1		± 1		± 1	μA
		5.5 V			± 0.5		± 5		± 5	
I_{OZ}	$V_O = V_{CC}$ or GND	5.5 V			± 0.5		± 5		± 5	μA
I_{CC}	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8		80		80	μA
C_i	$V_I = V_{CC}$ or GND	5 V			4.5					pF
C_o	$V_O = V_{CC}$ or GND	5 V			12					pF

† Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

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switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$T_A = 25^\circ\text{C}$			54AC16240		74AC16240		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A	Y	1.8	5.4	7.5	1.8	8.3	1.8	8.3	ns
t_{PHL}			2.5	7	9.3	2.5	10.2	2.5	10.2	
t_{PZH}	\overline{OE}	Y	2.1	6.1	8.5	2.1	9.5	2.1	9.5	ns
t_{PZL}			2.9	8.4	11.3	2.9	12.6	2.9	12.6	
t_{PHZ}	\overline{OE}	Y	4.3	6.2	8.3	4.3	8.7	4.3	8.7	ns
t_{PLZ}			3.6	6	7.8	3.6	8.4	3.6	8.4	

switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$T_A = 25^\circ\text{C}$			54AC16240		74AC16240		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A	Y	1.3	3.3	5.3	1.3	5.8	1.3	5.8	ns
t_{PHL}			1.9	4.3	6.5	1.9	7.1	1.9	7.1	
t_{PZH}	\overline{OE}	Y	1.6	3.8	5.9	1.6	6.6	1.6	6.6	ns
t_{PZL}			3.2	4.7	7.2	3.2	8.1	3.2	8.1	
t_{PHZ}	\overline{OE}	Y	4.2	6	7.7	4.2	8.1	4.2	8.1	ns
t_{PLZ}			3.4	5.1	6.9	3.4	7.3	3.4	7.3	

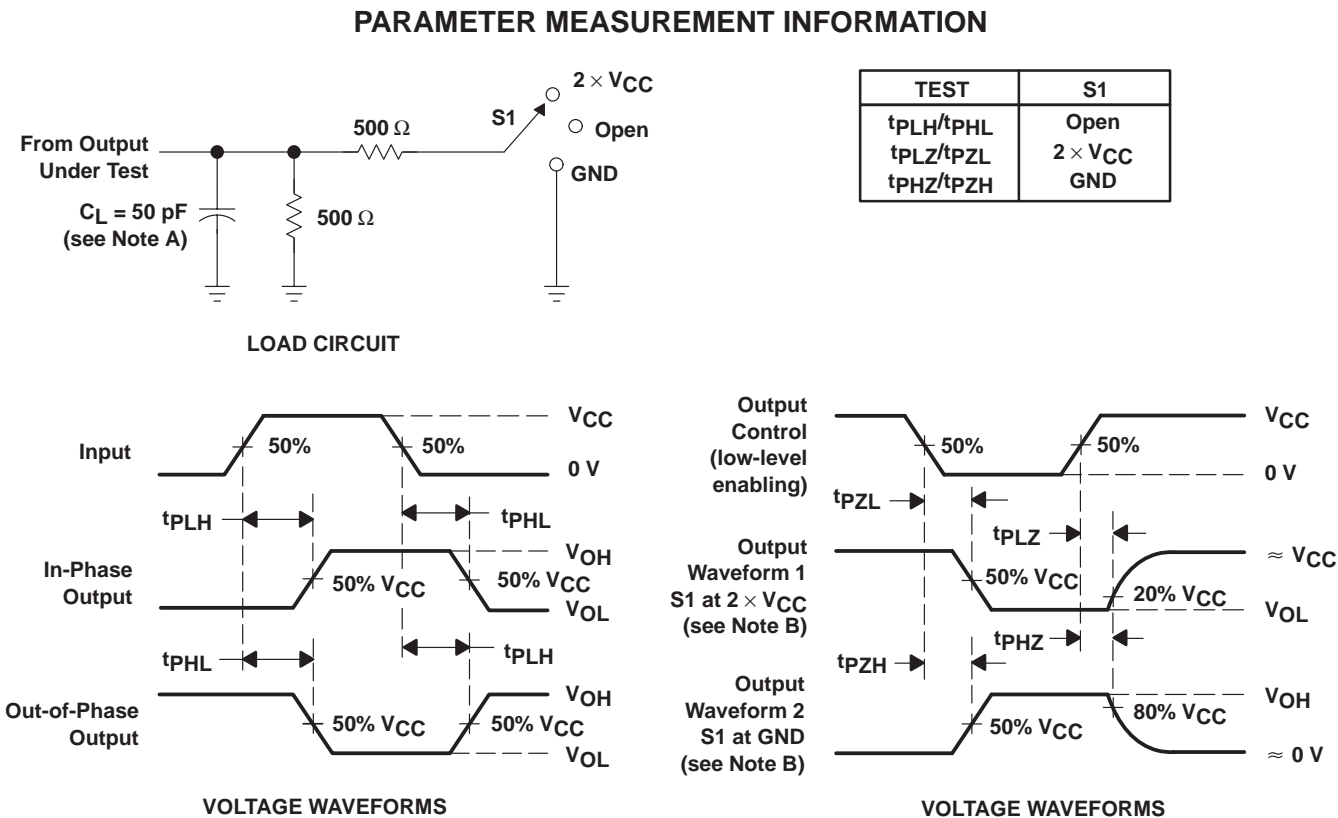
operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER			TEST CONDITIONS		TYP	UNIT
C_{pd}	Power dissipation capacitance per latch	Outputs enabled	$C_L = 50 \text{ pF}$, $f = 1 \text{ MHz}$		42	pF
		Outputs disabled			6	

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